

Description

The TD303X-4L, TD304X-4L, TD306X-4L and TD308X-4L series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon zero-cross photo triac in a plastic DIP4 package with different lead forming options.

With the robust coplanar double mold structure, TD303X-4L, TD304X-4L, TD306X-4L and TD308X-4L series provide the most stable isolation feature.

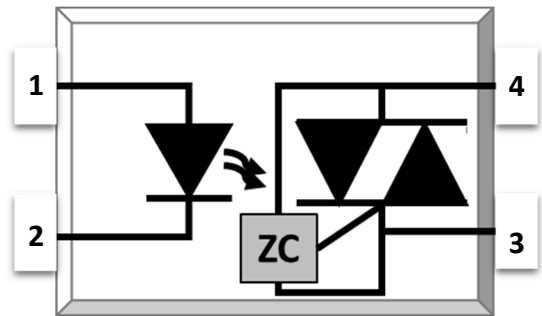
Features

- High isolation 5000 VRMS
- DC input with zero-cross photo triac output
- Operating temperature range - 40 °C to 100 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals (Pending Approved)
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC – GB4943.1, GB8898

Applications

- Solenoid/valve controls
- Lighting controls
- Motor controls
- Temperature controls
- Static AC power switches
- Solid state relays
- Interfacing microprocessors to 115 to 240VAC peripherals

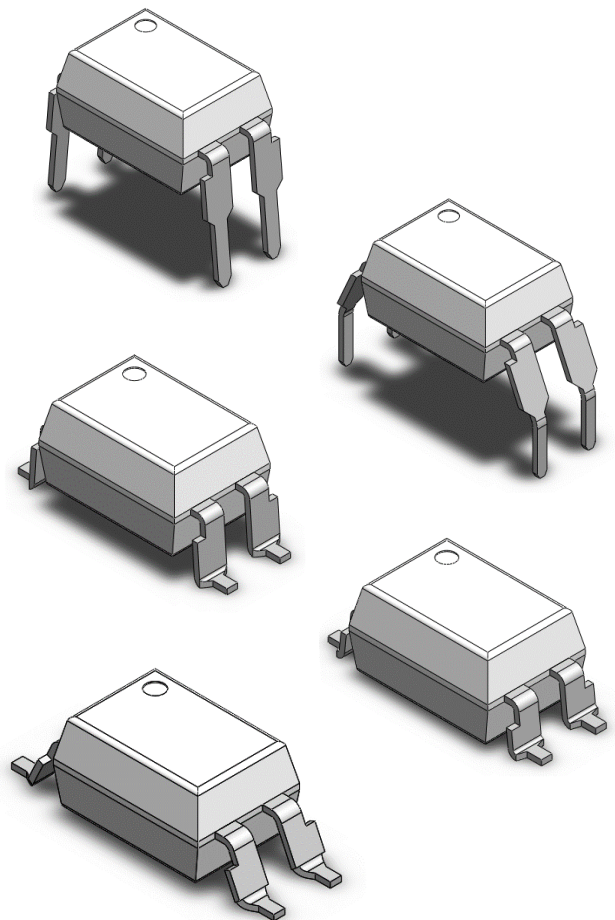
SCHEMATIC



PIN DEFINITION

1. Anode
2. Cathode
3. Terminal
4. Terminal

PACKAGE OUTLINE





ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	I _F	60	mA	
Reverse Voltage	V _R	6	V	
Junction Temperature	T _j	125	°C	
Input Power Dissipation	P _I	100	mW	
OUTPUT				
Off-state Output Terminal Voltage	TD303X-4L	250	V	
	TD304X-4L	400		
	TD306X-4L	600		
	TD308X-4L	800		
Peak Repetitive Surge Current PW=100μs, 120pps	I _{TSM}	1	A	
Junction Temperature	T _j	125	°C	
Output Power Dissipation	P _O	300	mW	
COMMON				
Total Power Dissipation	P _{tot}	400	mW	
Isolation Voltage	V _{iso}	5000	V _{rms}	1
Operating Temperature	T _{opr}	-40~100	°C	
Storage Temperature	T _{stg}	-55~150	°C	
Soldering Temperature	T _{sol}	260	°C	2

Note 1. AC For 1 Minute, R.H. = 40 ~ 60%

Note 2. For 10 seconds



DIP4, DC Input, Zero-Cross Photo TRIAC Optocoupler

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V _F	-	1.24	1.4	V	I _F =10mA	
Reverse Current	I _R	-	-	10	μA	V _R =6V	
Input Capacitance	C _{in}	-	8.5	250	pF	V=0, f=1kHz	
OUTPUT							
Peak Off-state Current, Either Direction	I _{DRM}	-	-	100	nA	V _{DRM} =Rated V _{DRM} I _F =0	3
Peak On-state Current, Either Direction	V _{TM}	-	1.42	2.5	V	I _{TM} =100mA	
Critical Rate of Rise of Off-state Voltage	dV/dt	1000	-	-	V/μs	V _{PEAK} =Rated V _{DRM}	4
TRANSFER CHARACTERISTICS							
LED Trigger Current	TD3031-4L,TD3041-4L, TD3061-4L,TD3081-4L		-	-	15	Terminal Voltage = 3V I _{TM} =100mA	
	TD3032-4L,TD3042-4L, TD3062-4L,TD3082-4L	I _{FT}	-	-	10		
	TD3033-4L,TD3043-4L, TD3063-4L,TD3083-4L		-	-	5		
Holding Current	I _H	-	250	-	μA		
Isolation Resistance	R _{iso}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C _{io}	-	0.4	1	pF	V=0, f=1MHz	
ZERO-CROSSING CHARACTERISTICS							
Inhibit Voltage	V _{INH}	-	-	20	V	I _F =Rated I _{FT}	
Leakage in Inhibited State	I _{DRM2}	-	-	500	μA	I _F =Rated I _{FT} V _{DRM} =Rated V _{DRM}	

Note3. Test voltage must be applied within dV/dt rating.

Note4. Refer to Fig.17 & Fig.18

CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Ambient Temperature

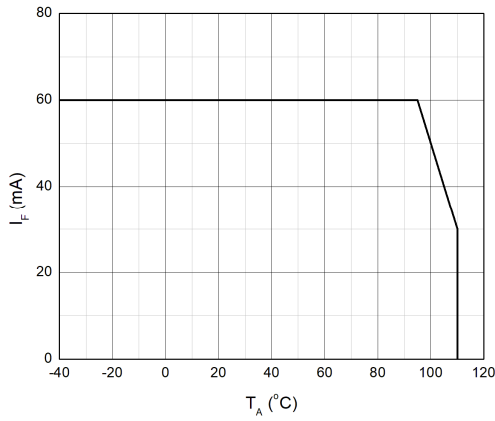


Fig.2 On-state Terminal Current vs. Ambient Temperature

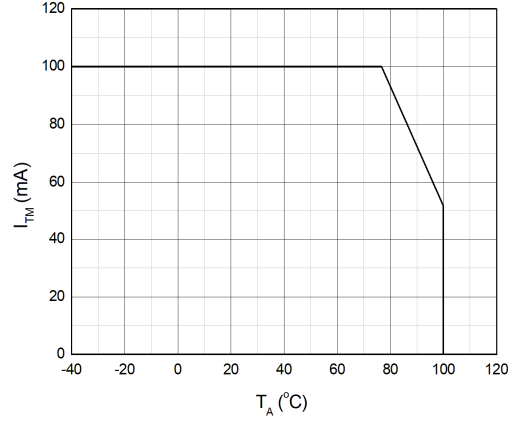


Fig.3 Forward Current vs. Forward Voltage

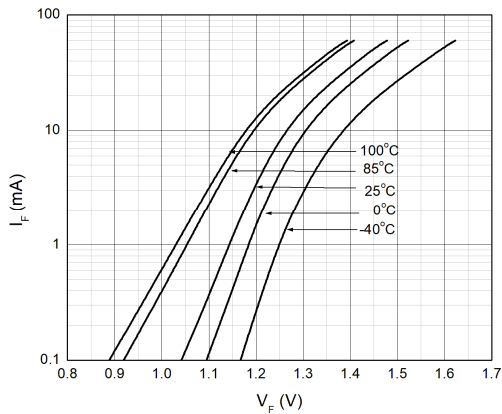


Fig.4 Off-state Terminal Current vs. Ambient Temperature

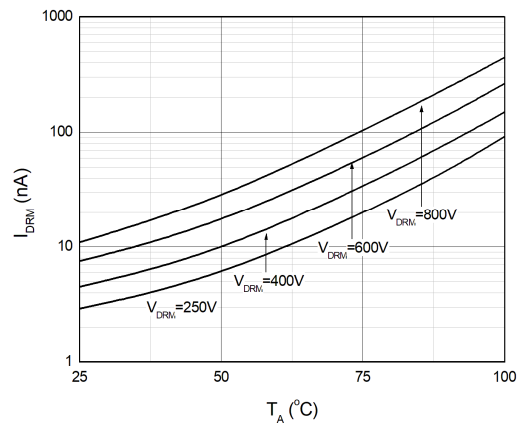


Fig.5 Normalized Off-state Terminal Voltage vs. Ambient Temperature

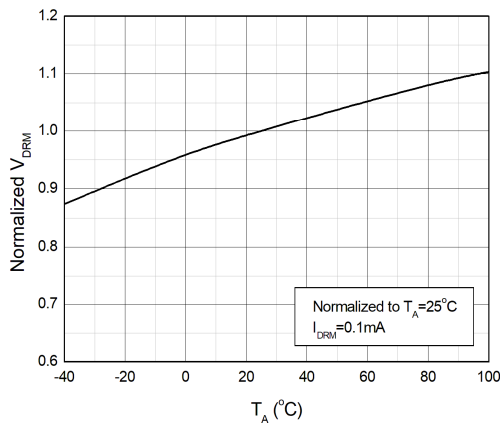
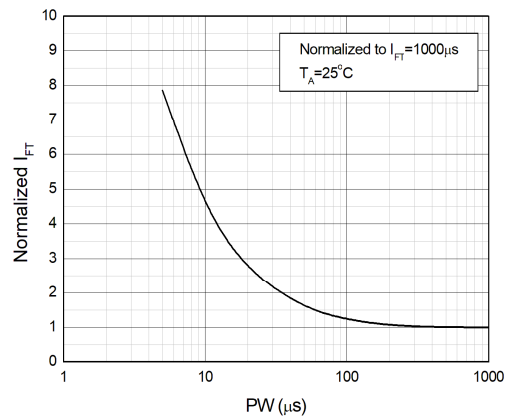
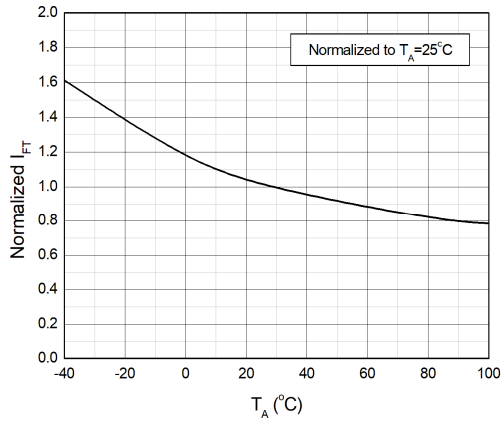
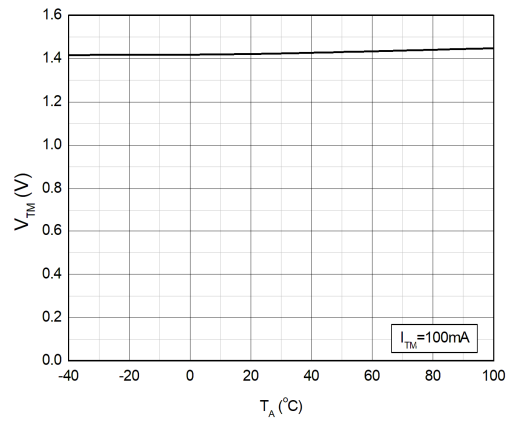
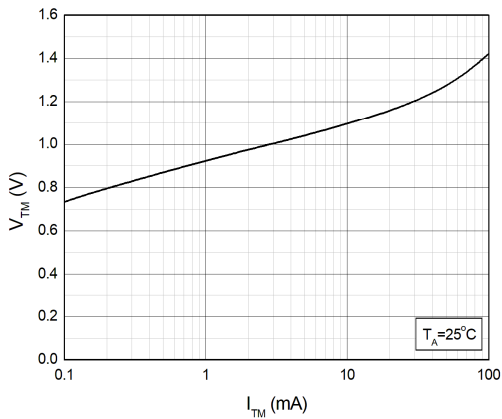
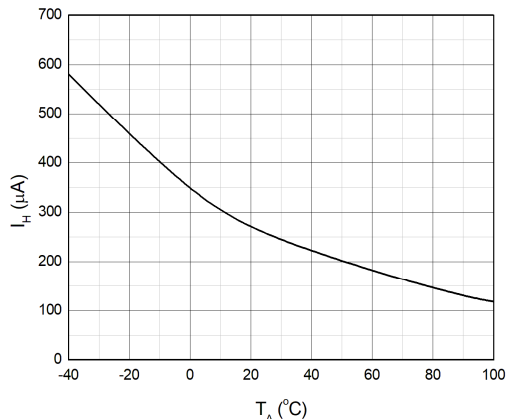
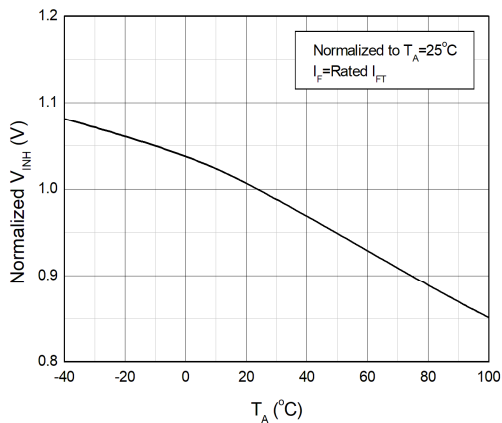
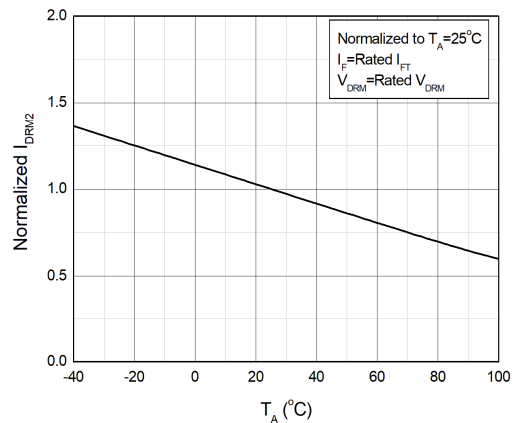
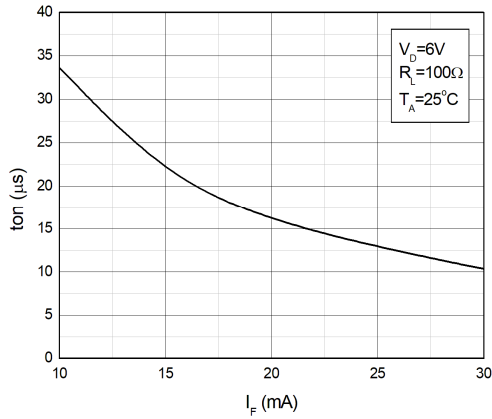
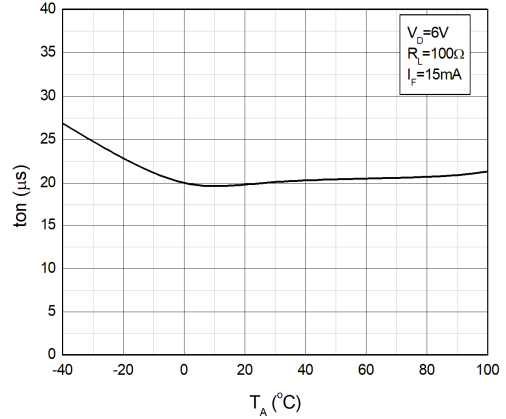
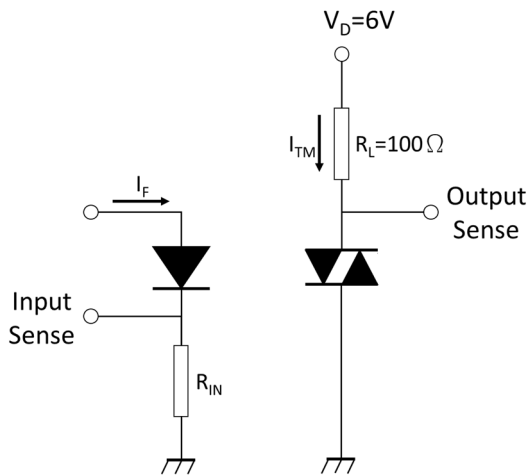
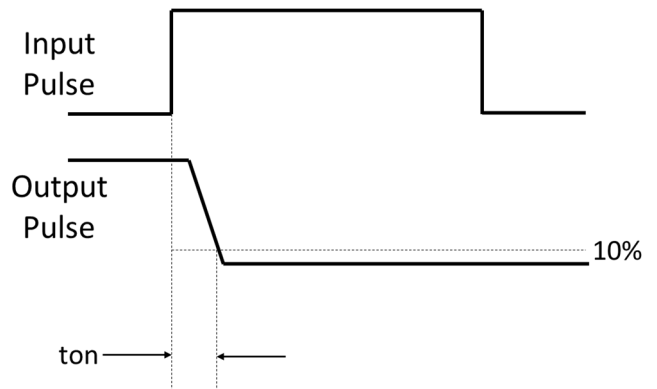
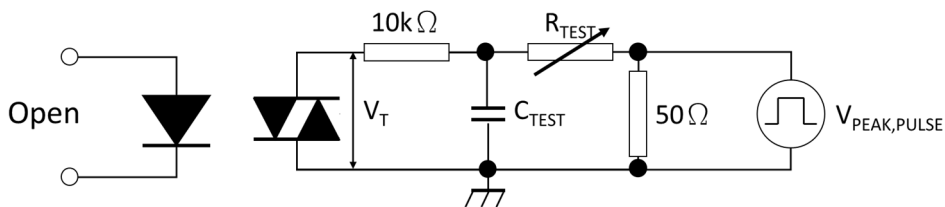
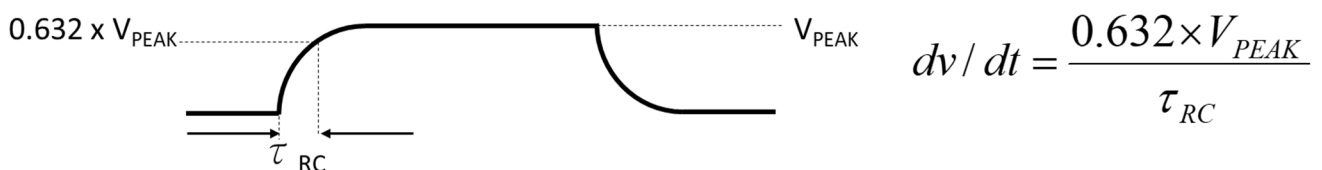


Fig.6 Normalized Trigger Current vs. LED Trigger Pulse Width

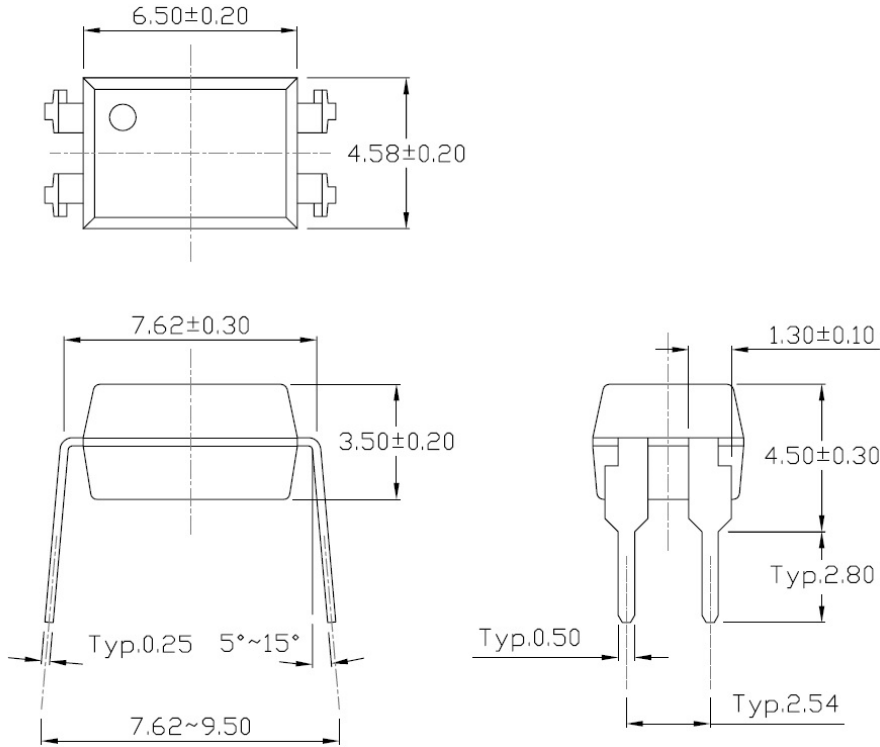


CHARACTERISTIC CURVES
Fig.7 Normalized Trigger Current vs. Ambient Temperature

Fig.8 On-state Terminal Voltage vs. Ambient Temperature

Fig.9 On-state Terminal Voltage vs. On-state Terminal Current

Fig.10 Holding Current vs. Ambient Temperature

Fig.11 Normalized Inhibit Voltage vs. Ambient Temperature

Fig.12 Normalized Leakage in Inhibit State vs. Ambient Temperature


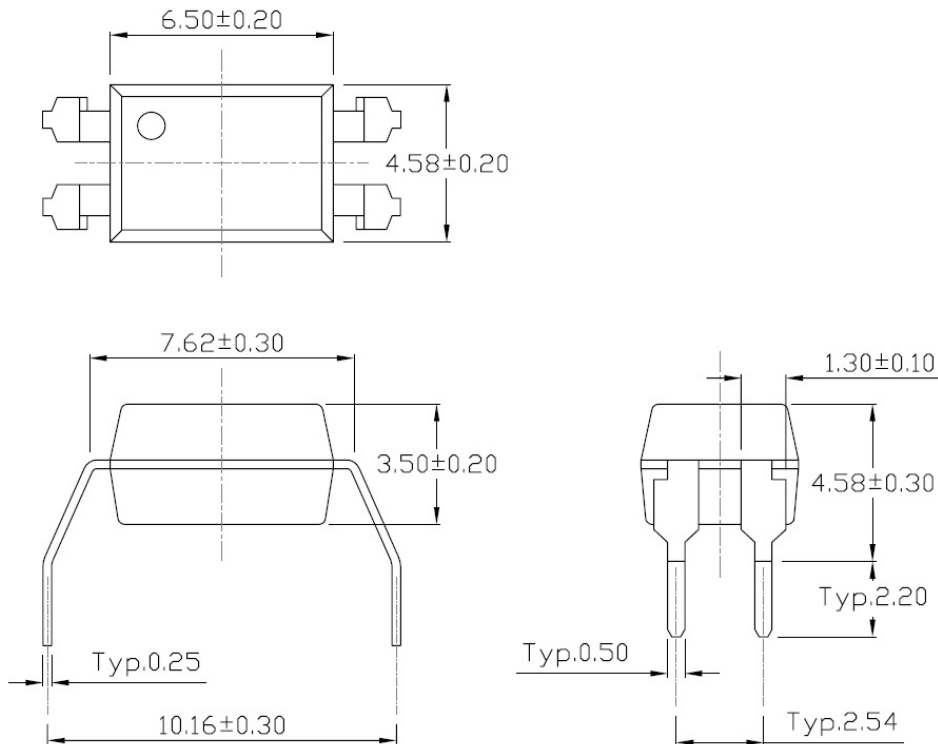
CHARACTERISTIC CURVES
Fig.13 Turn On Time vs. Forward Current

Fig.14 Turn On Time vs. Ambient Temperature

TEST CIRCUITS
Fig.15 Test Circuits of Turn On Time

Fig.16 Waveforms of Turn On Time

Fig.17 Test Circuits of dV/dt

Fig.18 Waveforms of dV/dt


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard DIP – Through Hole (DIP Type)

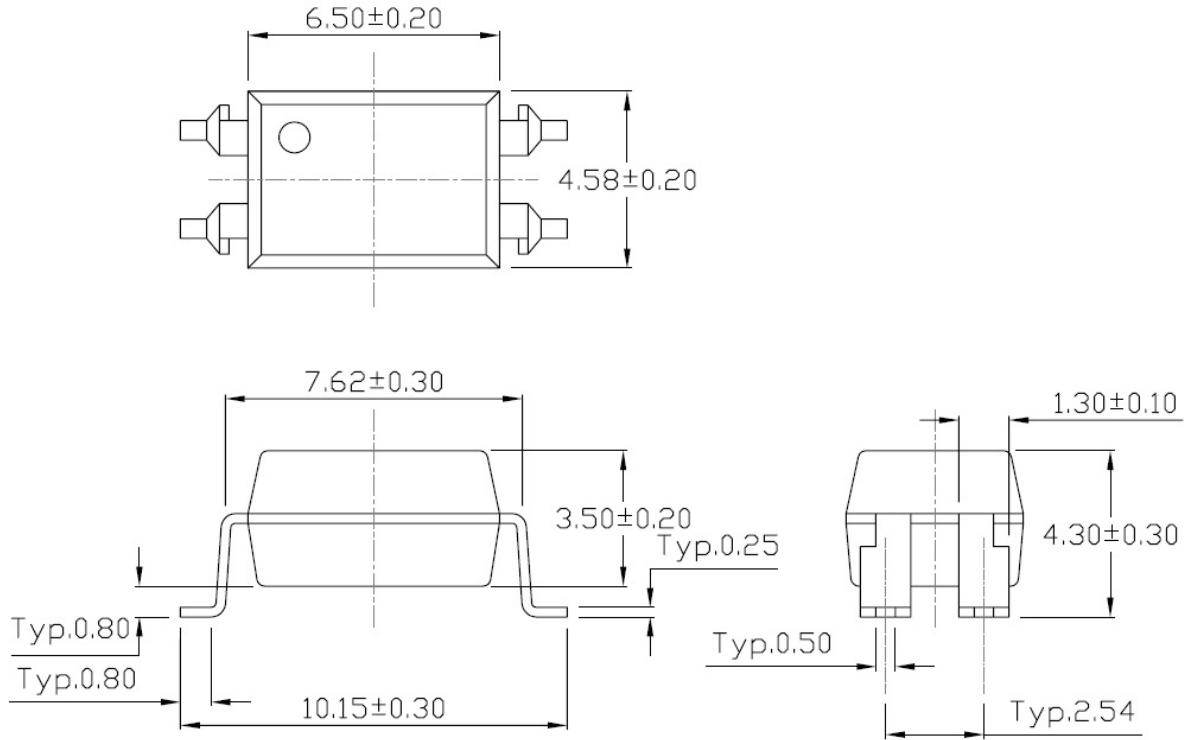


Gullwing (400mil) Lead Forming – Through Hole (M Type)

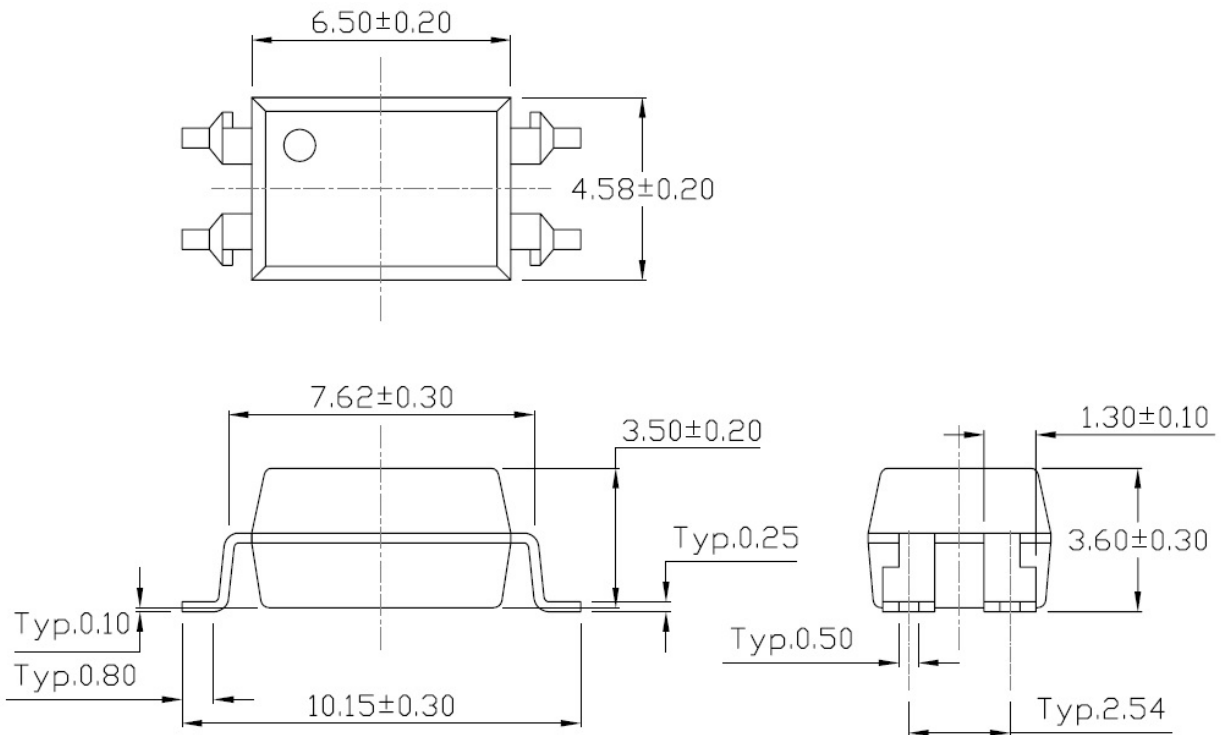


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming (S Type)

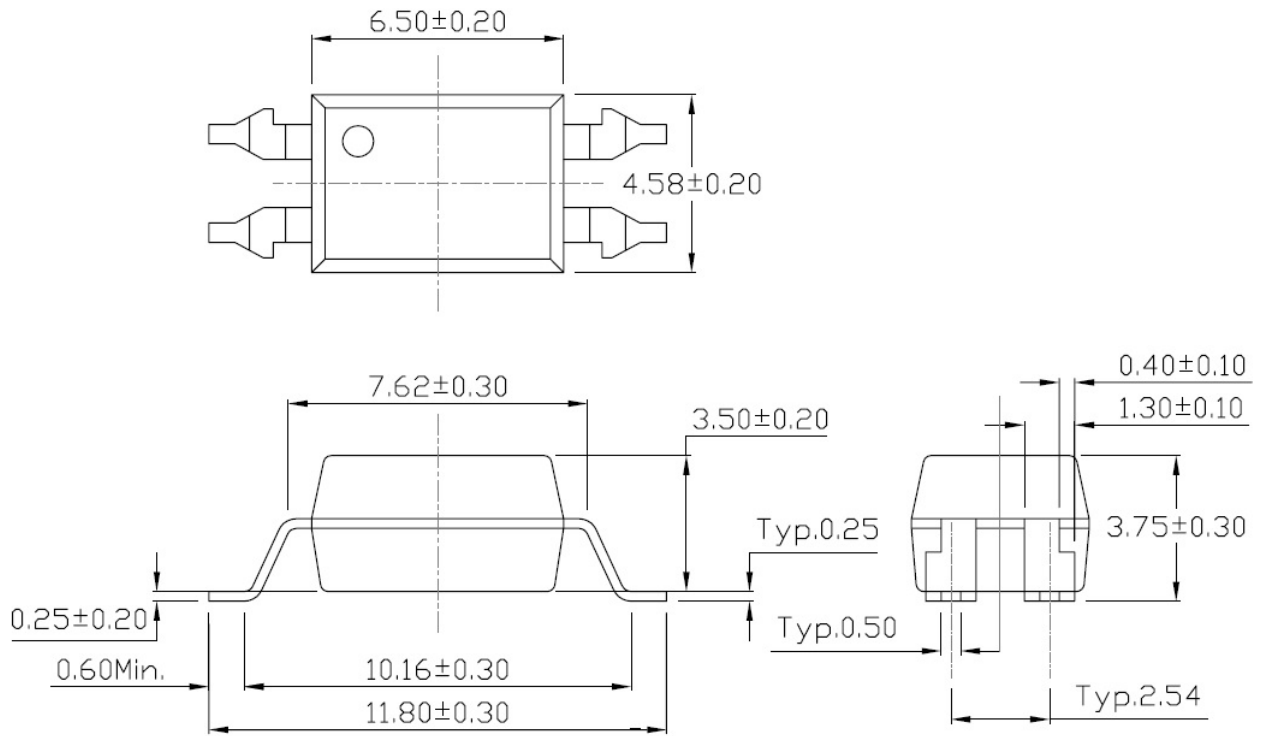


Surface Mount (Low Profile) Lead Forming (SL Type)



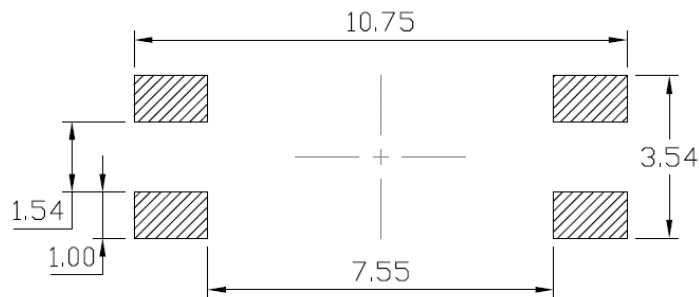
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount (Gullwing) Lead Forming (SLM Type)

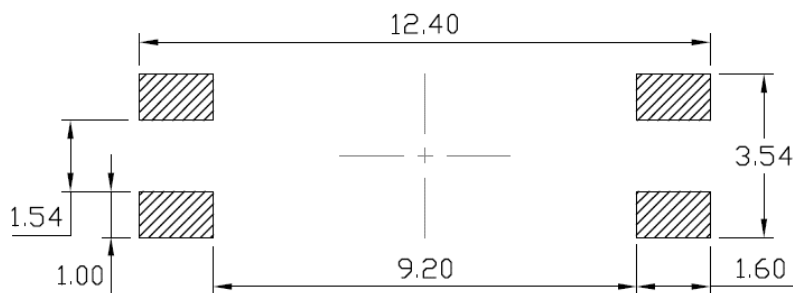


RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

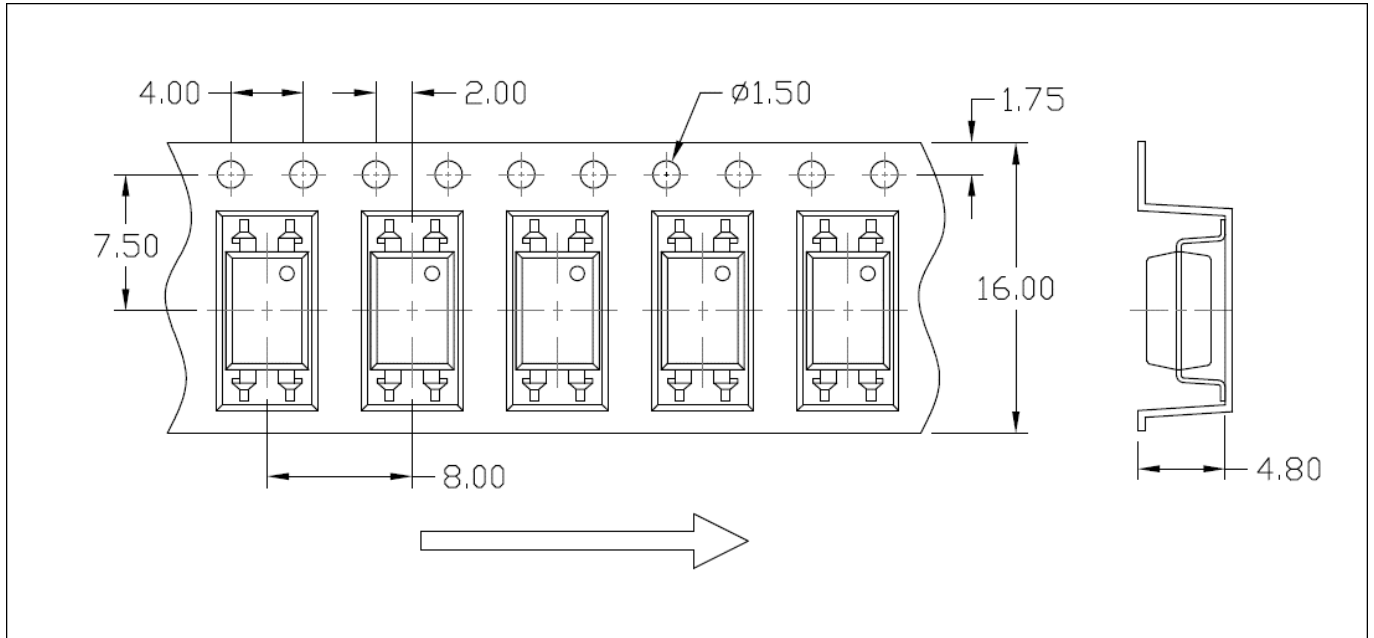


Surface Mount (Gullwing) Lead Forming

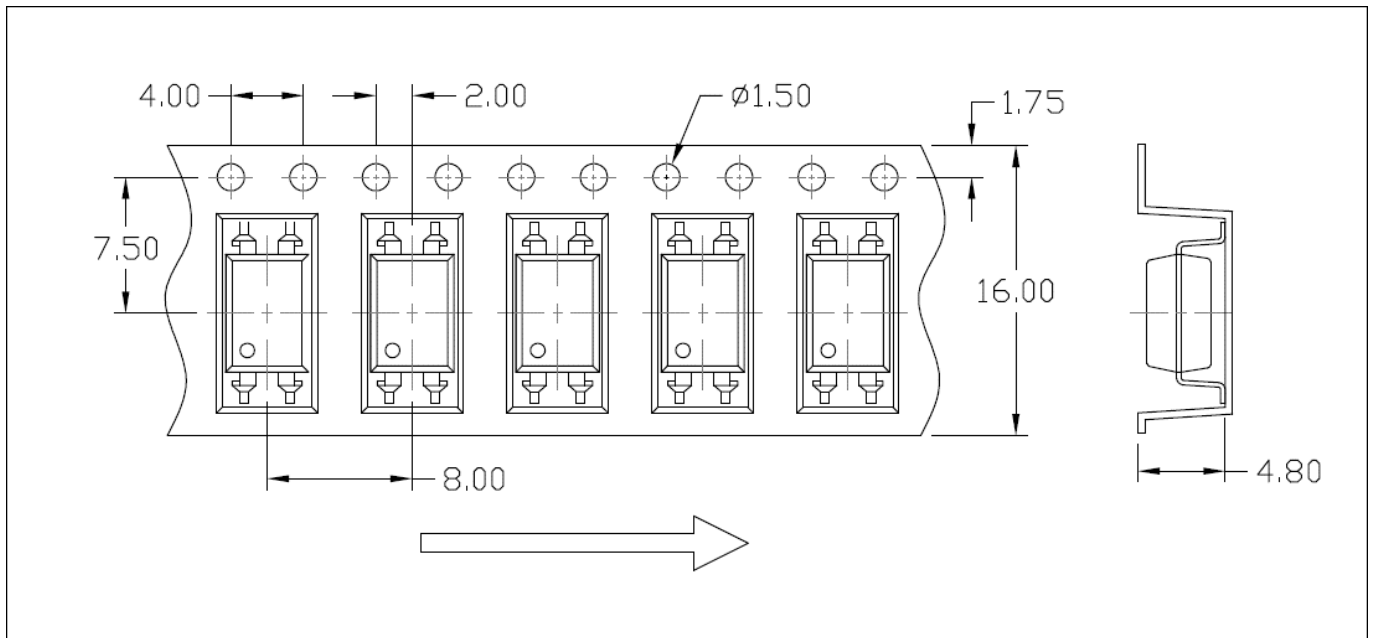


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)

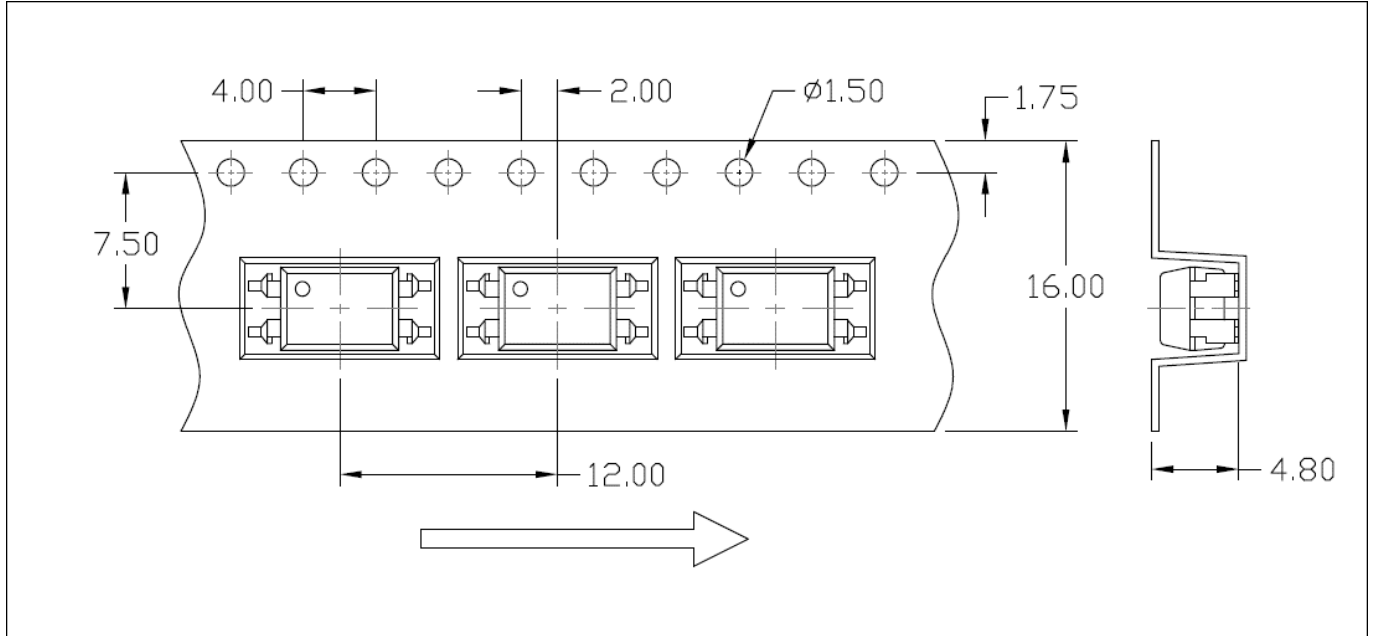


Option S(T2) & SL(T2)

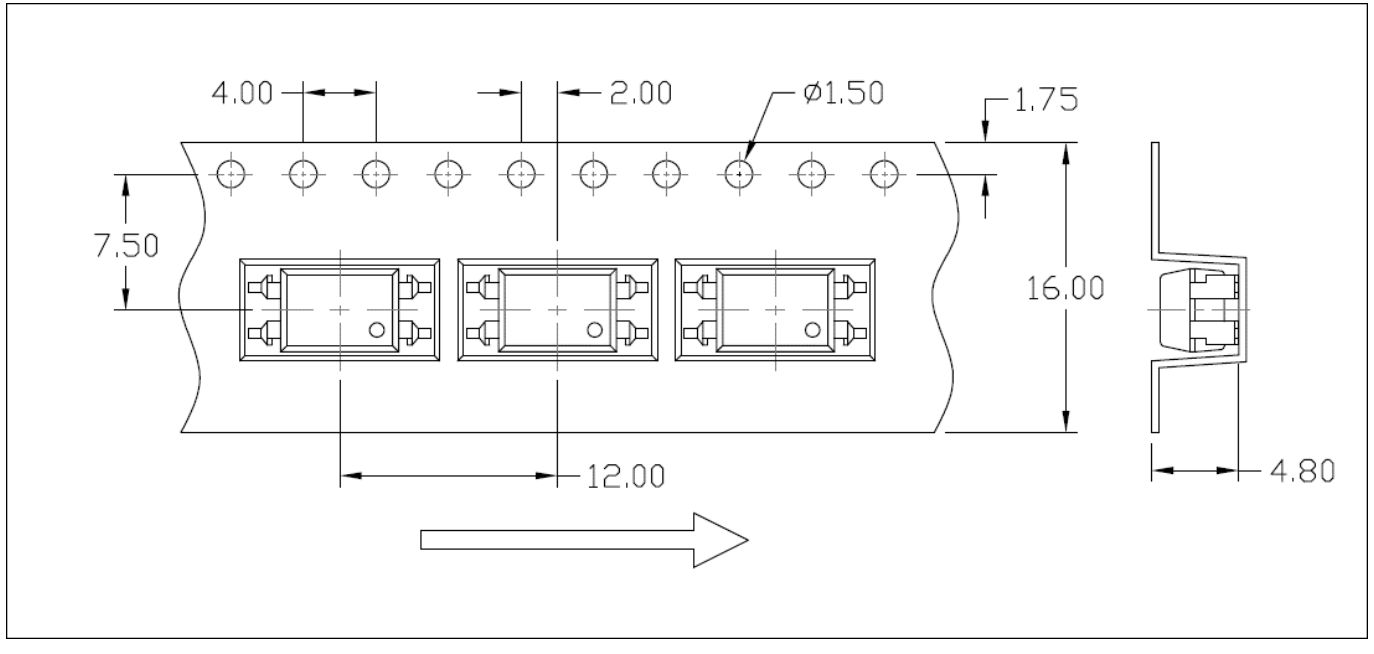


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T3) & SL(T3)

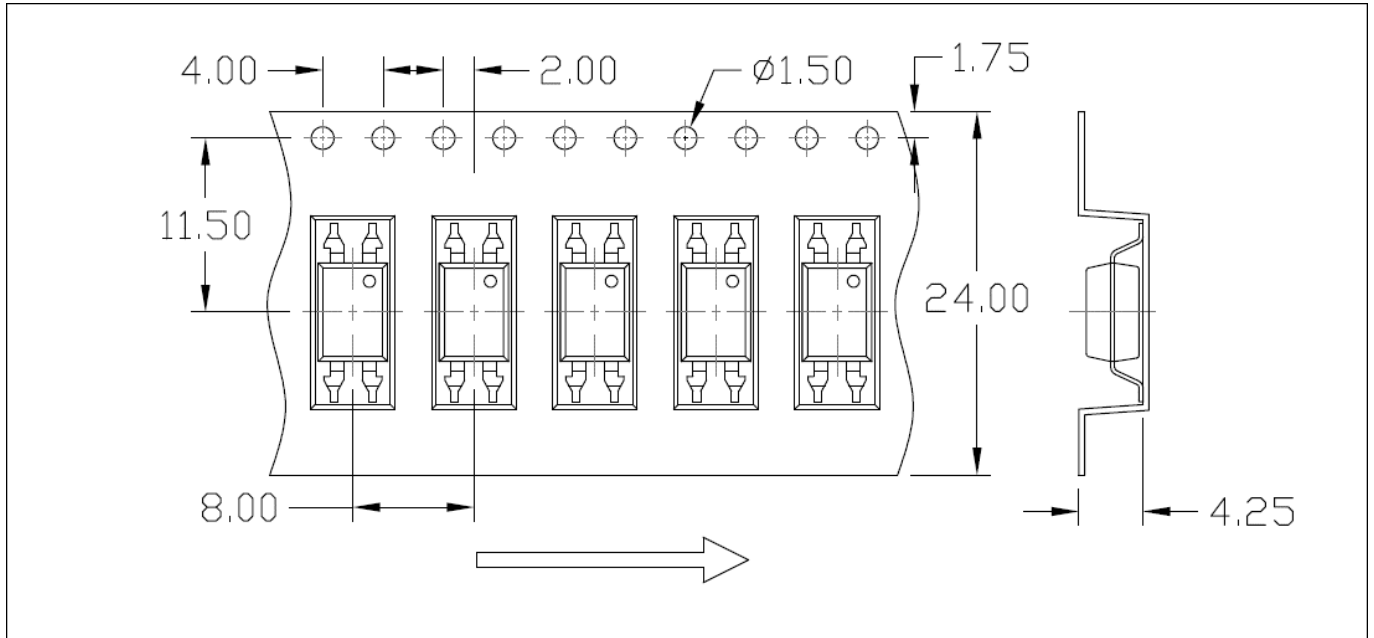


Option S(T4) & SL(T4)

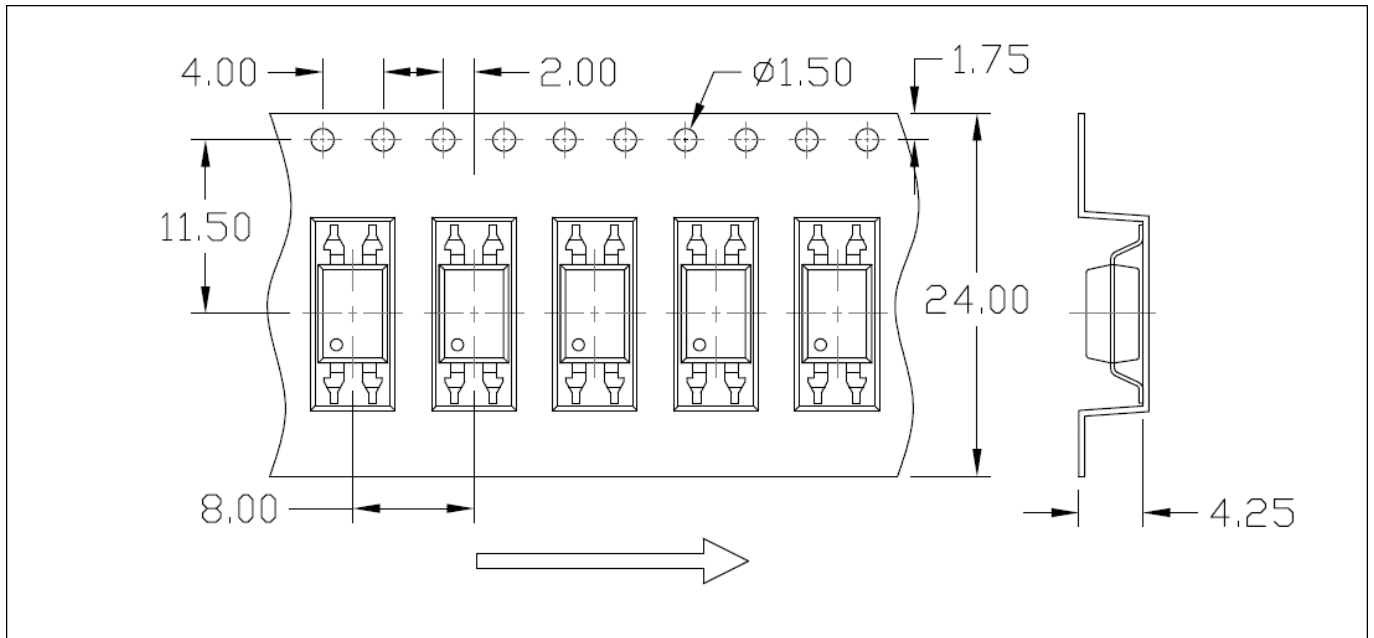


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option SLM(T1)



Option SLM(T2)





ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.
30XX : Part Number & Rank
V : VDE Option
Y : Fiscal Year
A : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

TD30XX-4L(Y)(Z)-GV

TD – Company Abbr.
 30XX – Rank
 (31/32/33/41/42/43/
 61/62/63/81/82/83)

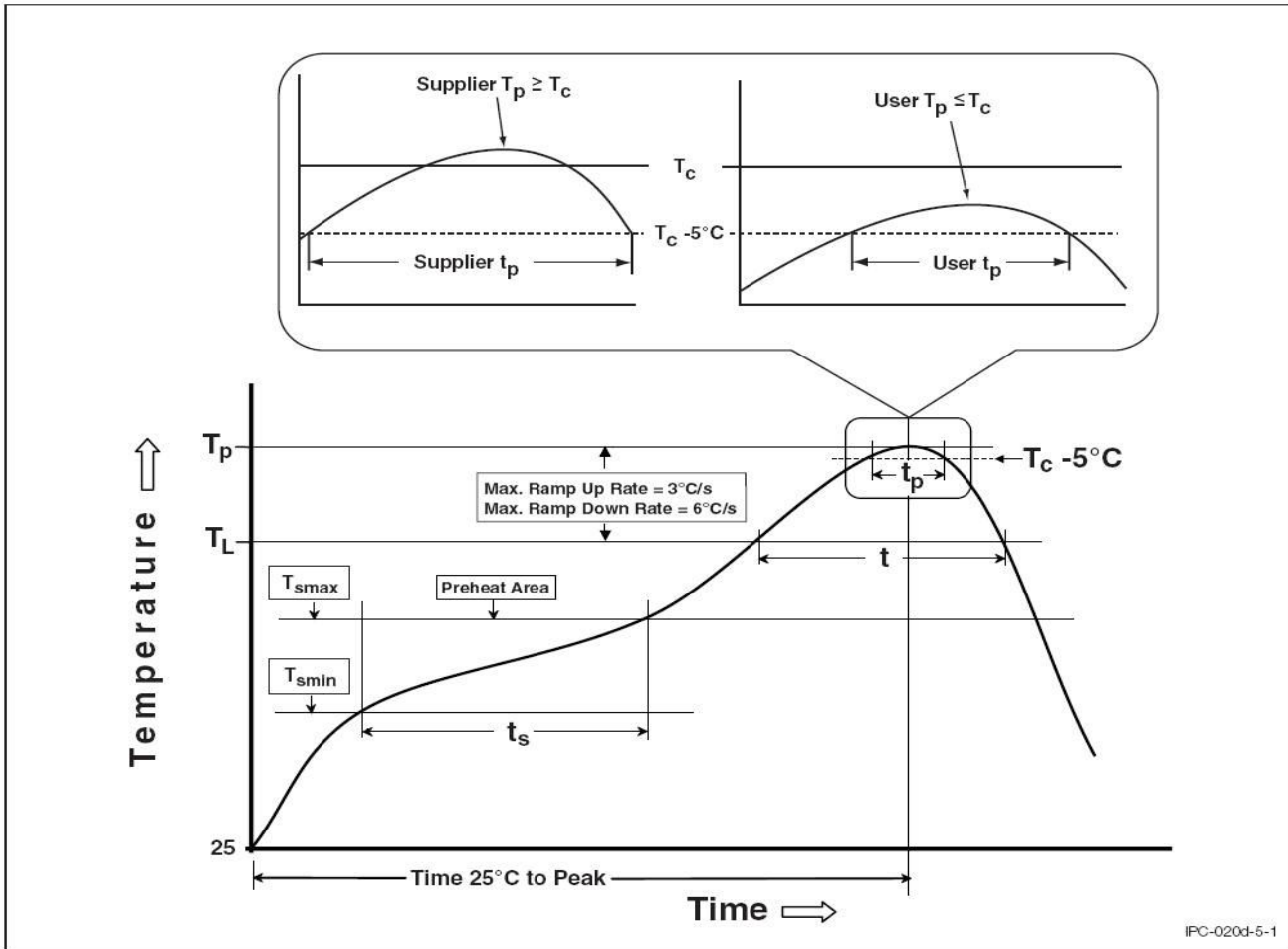
Y – Lead Form Option (M/S/SL/SLM/None)
 Z – Tape and Reel Option (T1/T2/T3/T4)
 G – Green
 V – VDE Option (V or None)

Packing Quantity

Option	Description	Quantity
None	Standard 4 Pin Dip	100 Units/Tube
M	Gullwing (400mil) Lead Forming	100 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1500 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1500 Units/Reel
S(T3)	Surface Mount Lead Forming – With Option 3 Taping	1000 Units/Reel
S(T4)	Surface Mount Lead Forming – With Option 4 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1500 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1500 Units/Reel
SL(T3)	Surface Mount (Low Profile) Lead Forming– With Option 3 Taping	1000 Units/Reel
SL(T4)	Surface Mount (Low Profile) Lead Forming – With Option 4 Taping	1000 Units/Reel
SLM(T1)	Surface Mount (Gullwing) Lead Forming– With Option 1 Taping	1500 Units/Reel
SLM(T2)	Surface Mount (Gullwing) Lead Forming – With Option 2 Taping	1500 Units/Reel

REFLOW INFORMATION

REFLOW PROFILE



IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



DISCLAIMER

- LIGHTNING is continually improving the quality, reliability, function and design. LIGHTNING reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.